

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
ANIRUDHA V. SUMANT	06/21/2017
KIRAN KUMAR KOVI	06/22/2017
RECEIVING PARTY DATA	
Name:	UCHICAGO ARGONNE, LLC
Street Address:	5801 SOUTH ELLIS AVENUE
City:	CHICAGO
State/Country:	ILLINOIS
Postal Code:	60637
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15240594
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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ATTORNEY DOCKET NUMBER:	051583-0706
NAME OF SUBMITTER:	MATTHEW E. MARTIN
SIGNATURE:	/Matthew E. Martin/
DATE SIGNED:	07/24/2017
Total Attachments: 2	
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source=051583-0706 Assignment#page2.tif	

ASSIGNMENT

I, Anirudha V. Sumant of the City of Plainfield, in the State of Illinois, for good and valuable considerations to me in hand paid, the receipt and sufficiency whereof is hereby acknowledged, have sold, assigned, conveyed and set over, and do hereby sell, assign, convey and set over unto UChicago Argonne, LLC, having a place of business at 5801 South Ellis Avenue, Chicago, Illinois 60637, its successors and assigns, the entire right, title and interest in and to all subject matter invented or designed by me and disclosed in the patent application for the, "SYSTEMS AND METHODS FOR FORMING DIAMOND HETEROJUNCTION JUNCTION DEVICES" (ANL-IN-15-097) filed in the U.S. Patent and Trademark Office on August 18, 2016, as U. S. Application Serial No. 15/240,594, executed by me on the date hereinafter set forth, and any divisions or continuations thereof, including any reissues and extensions thereof that may be obtained therefor, and the right, where such right can be legally exercised, in its own name to apply for and obtain Letters Patent, Inventor's Certificates, Utility Models and Designs, in countries foreign to the United States, including the full right to claim for any such application the benefits of the International Convention as fully and entirely as I could have done if the application had been in my name, and the entire interest in any Letters Patent, Inventor's Certificate, Utility Model or Design which may be granted on any such application in such foreign country; and we hereby authorize and request the Commissioner of Patents and Trademarks of the United States, and any official of any country or countries foreign to the United States whose duty it is to issue Letters Patent, Inventors Certificates, Utility Models or Designs, on applications as aforesaid, to issue any and all Letters Patent, Inventor's Certificates, Utility Models and Designs that may be granted for said invention to said UChicago Argonne, LLC, its successors and assigns.

And for the above-named considerations, I hereby agree that I will without additional compensation but without cost to myself, promptly communicate to said UChicago Argonne, LLC, its successors and assigns, any facts known to us respecting said invention whenever requested, and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuing and reissue applications for Letters Patent, Inventor's Certificates, Utility Models and Designs and assignments thereof, make all rightful oaths and generally do everything possible to aid said assignee, its successors and assigns, as and when requested by them, in obtaining and enforcing proper Letters Patents, Inventor's Certificate, Utility Model and Design protection for said invention or inventions and improvements, in the United States and in all other countries.

Anirudha V. Sumant
Printed Name

06/21/17
Printed Date

AV Sumant
Signature

06/21/17
Dated

Kathryn L. Tietz
Witness Printed Name

06/21/17
Printed Date

Kathryn L. Tietz
Witness Signature

6/21/17
Date

ASSIGNMENT

I, Kiran Kumar Kovi for good and valuable considerations to me in hand paid, the receipt and sufficiency whereof is hereby acknowledged, have sold, assigned, conveyed and set over, and do hereby sell, assign, convey and set over unto UChicago Argonne, LLC, having a place of business at 5801 South Ellis Avenue, Chicago, Illinois 60637, its successors and assigns, the entire right, title and interest in and to all subject matter invented or designed by me and disclosed in the patent application for the, "SYSTEMS AND METHODS FOR FORMING DIAMOND Heterojunction Junction Devices" (ANL-IN-15-097) filed in the U.S. Patent and Trademark Office on August 18, 2016, as U. S. Application Serial No. 15/240,594, executed by me on the date hereinafter set forth, and any divisions or continuations thereof, including any reissues and extensions thereof that may be obtained therefor, and the right, where such right can be legally exercised, in its own name to apply for and obtain Letters Patent, Inventor's Certificates, Utility Models and Designs, in countries foreign to the United States, including the full right to claim for any such application the benefits of the International Convention as fully and entirely as I could have done if the application had been in my name, and the entire interest in any Letters Patent, Inventor's Certificate, Utility Model or Design which may be granted on any such application in such foreign country; and we hereby authorize and request the Commissioner of Patents and Trademarks of the United States, and any official of any country or countries foreign to the United States whose duty it is to issue Letters Patent, Inventor's Certificates, Utility Models or Designs, on applications as aforesaid, to issue any and all Letters Patent, Inventor's Certificates, Utility Models and Designs that may be granted for said invention to said UChicago Argonne, LLC, its successors and assigns.

And for the above-named considerations, I hereby agree that I will without additional compensation but without cost to myself, promptly communicate to said UChicago Argonne, LLC, its successors and assigns, any facts known to us respecting said invention whenever requested, and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuing and reissue applications for Letters Patent, Inventor's Certificates, Utility Models and Designs and assignments thereof, make all rightful oaths and generally do everything possible to aid said assignee, its successors and assigns, as and when requested by them, in obtaining and enforcing proper Letters Patents, Inventor's Certificate, Utility Model and Design protection for said invention or inventions and improvements, in the United States and in all other countries.

Kiran Kumar Kovi
Printed Name

06/22/17
Printed Date

[Signature]
Signature

06/22/2017
Dated

Anirudha V. Sumant
Witness Printed Name

06/22/17
Printed Date

[Signature]
Witness Signature

06/22/2017
Date

PATENT